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	CLASSIFICATION SE SUBCISS SUBC	PATENT NUMBER						
	MLED UNDER 35 U.S.C. 373							
	Class SSUE CL	·						
U.S. UTILITY Patent Application								
	O.I.P.E. PATENT DATE							
	141 SCANNED CARROLL AND							
AF	PPLICATION NO. 1							
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S	Visible 0 20 20 50	FF						
₽	Akihiko Imagawa Masahiko Yamaki							
APPLICANTS	Masataka Takamura							
AP.								
	Synthetic resin forming metal mold, metal mold bemperata regulating device, and metal mold temperature regulating	•						
THE STATE	and metal mold temps above temps at	4t°C						
F		7 method						
		PTO-2040						
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ISSUING CLASSIFICATION **ORIGINAL** CROSS REFERENCE(S) CLASS **SUBCLASS** CLASS SUBCLASS (ONE SUBCLASS PER BLOCK) INTERNATION AL CLASSIFICATION Continued on Issue Slip Inside File Jacket

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G
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	(Assistant Examiner);		(Date)		
The term of this patent shall not extend beyond the expiration date of U.S Patent. No					
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VARNING:	(Legal Instruments Examiner)		(Date)		
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